



2 CONTACT AREA:GOLD PLATING 0.2μm MIN
TERMINAL AREA:GOLD PLATING 0.03μm MIN
UNDER PLATING:NICKEL PLATING 2μm MIN

UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.	APPROVED :RI. TAKAYASU		12. 10. 17	DRAWING NO. EDC3-022423-01				
	CHECKED :EJ. WAKATSUKI		12. 10. 17	PART NO. HDAB-15PF(05)				
	DESIGNED :MO. SHIMOYAMA		12. 10. 17	CODE NO. CL211-0563-3-05				
	DRAWN :TY. ITO		12. 10. 16	 1/				